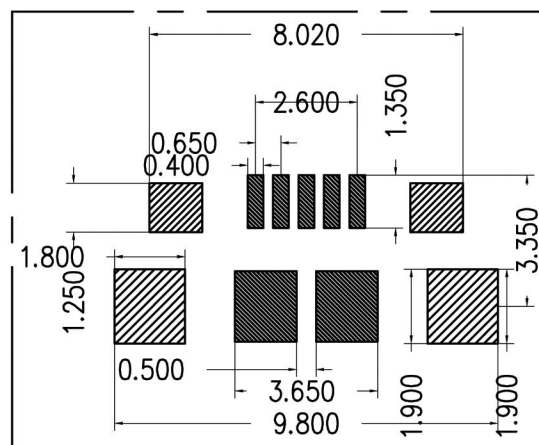
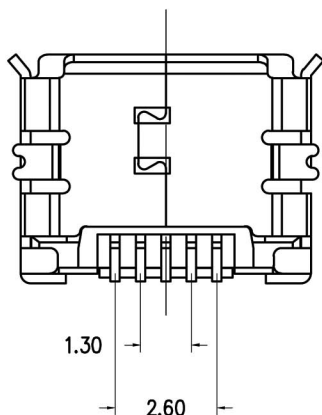
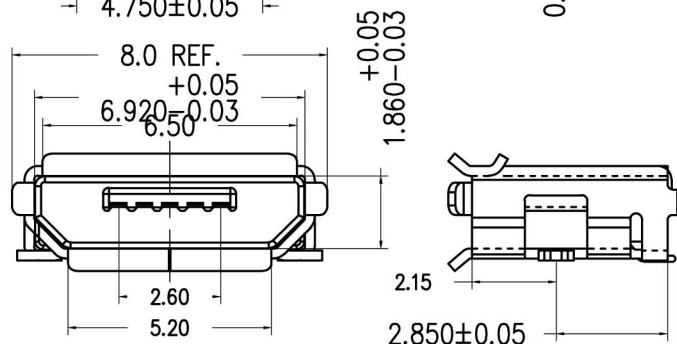
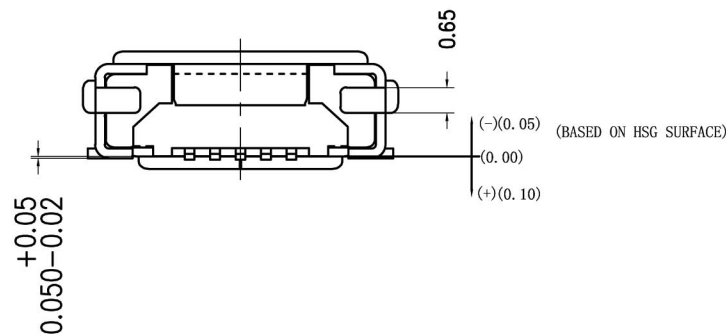
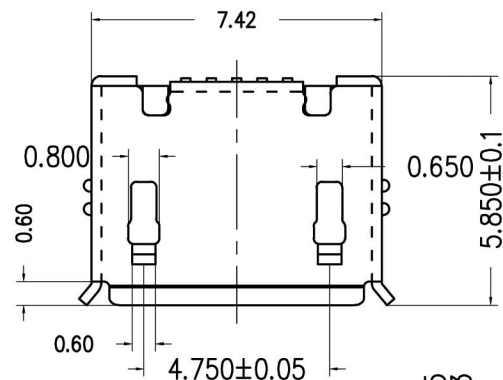




PCB LAYOUT

Specifications:

Electrical:

1. Current Rating:1.0A/contact terminal
2. Voltage Rating: 30V DC
3. Contact Resistance:50 milliohms MAX
4. Dielectric Withstanding Voitage: 300 V AC AT Sea Level
5. Insulation Resistance: 100MEGA ohms MIN

Mechanical:

1. Connector Mate and Unmate Force:
Mate force:3.0kgf (MAX)
Unmate force:0.7kgf (MIN)
2. Terminal Retention:0.5kgf (MIN)

Material:

1. Housing: High Temperature Thermoplastics, Lcp
 2. Contact:Copper Alloy C2680
 3. Shell: C2680
- Finish:
1. Contact: Plated Gold in Mating Area;
Tin On Solder Tails
 2. Shell:Shell:Nickel Plating

**RoHS
Compliant**

HSM 玄茂科技股份有限公司
HSUAN MAO TECHNOLOGY CO., LTD.

APPD.
核准



SCALE
比例 参考

DWG.
製圖

Hedy

UNIT
單位

SIZE.
紙張尺寸

DATE 制表日

2015/08/06

PAGE
張數

REV.
版次

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B

PART NAME 品名

Micro USB B TYPE FEMALE 5P SMT TYPE(P.C.B TYPE)
WITHOUT LOCATING PEG MATTE TIN SHELL
BLACK COLOR HOUSING MATERIAL:LCP ROHS

PART NO.

料號 C8351-05BFDXNBFR

P/N	PART NAME	MATERIAL	PLATING OR COLOR	Q'TY
1	MICRO CONTACT	BRASS (C2680 EH)	GOLD	5
2	MICRO HOUSING	LCP	BLACK	1
3	MICRO SHELL	BRASS (C2680 EH)	MATTE TIN / NICKEL	1